TOSHIBA Field Effect Transistor Silicon P/N Channel MOS Type(π-MOSVI)

SSM6L16FE

High Speed Switching Applications

Analog Switch Applications

• Small package

• Low on-resistance Q1: $RDS(ON) = 4 \Omega \text{ (max) } (@VGS = 2.5 \text{ V})$

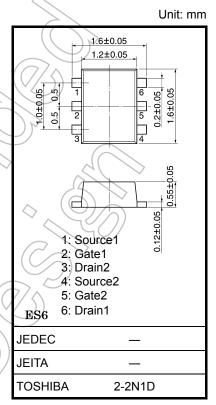
Q2: $R_{DS(ON)} = 12 \Omega \text{ (max) } (@V_{GS} = -2.5 \text{ V})$

Q1 Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-Source voltage		V _{DSS}	20	V
Gate-Source voltage		V_{GSS}	±10	^
Drain current	DC	I _D	100	(mA
	Pulse	I _{DP}	200	(IIIA)

Q2 Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-Source voltage		V _{DSS}	-20	N
Gate-Source voltage		V _{GSS}	±10	X
Drain current	DC	ID	-100	mA
	Pulse	IDP	-200	\ \



Weight: 3 mg (typ.)

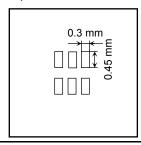
Absolute Maximum Ratings (Q1, Q2 Common) (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Power dissipation	P _D (Note 1)	150	mW
Channel temperature	T _{ch}	150	°C
Storage temperature range	T _{stg}	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

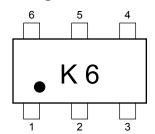
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Total rating, mounted on FR4 board (25.4 mm \times 25.4 mm \times 1.6 mm, Cu Pad: 0.135 mm $^2 \times$ 6)

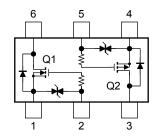


Start of commercial production 2002-03

Marking



Equivalent Circuit (top view)



Handling Precaution

When handling individual devices (which are not yet mounted on a circuit board), ensure that the environment is protected against static electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.



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90%

90%

10%

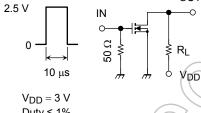
Q1 Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	MIN.	TYP.	MAX.	UNIT
Gate leakage current		I _{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$	_	_	±1	μА
Drain-Source breakdo	Drain-Source breakdown voltage		$I_D = 0.1 \text{ mA}, V_{GS} = 0$	20	_	_	V
Drain cut-off current		I _{DSS}	V _{DS} = 20 V, V _{GS} = 0	/	_	1	μА
Gate threshold voltage		V _{th}	$V_{DS} = 3 \text{ V}, I_D = 0.1 \text{ mA}$	0.6		1.1	V
Forward transfer admittance		Yfs	$V_{DS} = 3 \text{ V}, I_D = 10 \text{ mA}$ (Note2)	40) /_	_	mS
Drain-Source on-resistance		R _{DS} (ON)	$I_D = 10 \text{ mA}, V_{GS} = 4 \text{ V}$ (Note2)) <u> </u>	1.5	3.0	Ω
			$I_D = 10 \text{ mA}, V_{GS} = 2.5 \text{ V}$ (Note2)	\mathcal{D}	2.2	4.0	
			$I_D = 1 \text{ mA}, V_{GS} = 1.5 \text{ V}$ (Note2)		5.2	15	
Input capacitance		C _{iss}		_	9.3	_	pF
Reverse transfer capacitance		C _{rss}	$V_{DS} = 3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	4.5	_	pF
Output capacitance		Coss			9.8	\rightarrow	pF
Switching time	Turn-on time	t _{on}	$V_{DD} = 3 \text{ V, } I_{D} = 10 \text{ mA,}$ $V_{GS} = 0 \text{ to } 2.5 \text{ V}$	-6	70	> —	20
	Turn-off time	t _{off}		~_(125) —	ns

Note2: Pulse test

Switching Time Test Circuit



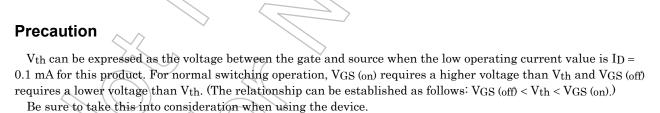


OUT

Duty ≤ 1% $V_{IN}\text{: }t_{r}\text{, }t_{f}<5\text{ ns}$

 $(Z_{out} = 50 \Omega)$

Common Source $Ta = 25^{\circ}C$



(b) V_{IN}

(c) Vout

 V_{DD}

V_{DS} (ON)

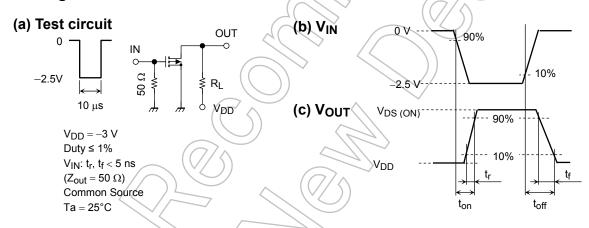
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Q2 Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	MIN.	TYP.	MAX.	UNIT
Gate leakage current		I _{GSS}	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$	_	_	±1	μА
Drain-Source breakdown voltage		V (BR) DSS	$I_D = -0.1 \text{ mA}, V_{GS} = 0$	-20	_	_	V
Drain cut-off current		I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0$	/	_	-1	μА
Gate threshold voltage		V _{th}	$V_{DS} = -3 \text{ V}, I_D = -0.1 \text{ mA}$	-0.6	_	-1.1	V
Forward transfer admittance		Y _{fs}	$V_{DS} = -3 \text{ V}, I_D = -10 \text{ mA}$ (Note3)	25) /_	_	mS
Drain-Source on-resistance		R _{DS} (ON)	$I_D = -10 \text{ mA}, V_{GS} = -4 \text{ V}$ (Note3)) <u> </u>	6	8	Ω
			$I_D = -10 \text{ mA}, V_{GS} = -2.5 \text{ V (Note3)}$	\mathcal{D}	8	12	
			$I_D = -1 \text{ mA}, V_{GS} = -1.5 \text{ V}$ (Note3))	18	45	
Input capacitance		C _{iss}		_	11	_	pF
Reverse transfer capacitance		C _{rss}	$V_{DS} = -3 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$	_	3.7	_	pF
Output capacitance		Coss			10	\rightarrow	pF
Switching time	Turn-on time	t _{on}	$V_{DD} = -3 \text{ V}, I_{D} = -10 \text{ mA},$	-6	130	> —	20
	Turn-off time	t _{off}	V _{GS} = 0 to -2.5 V	~_(190		ns

Note3: Pulse test

Switching Time Test Circuit



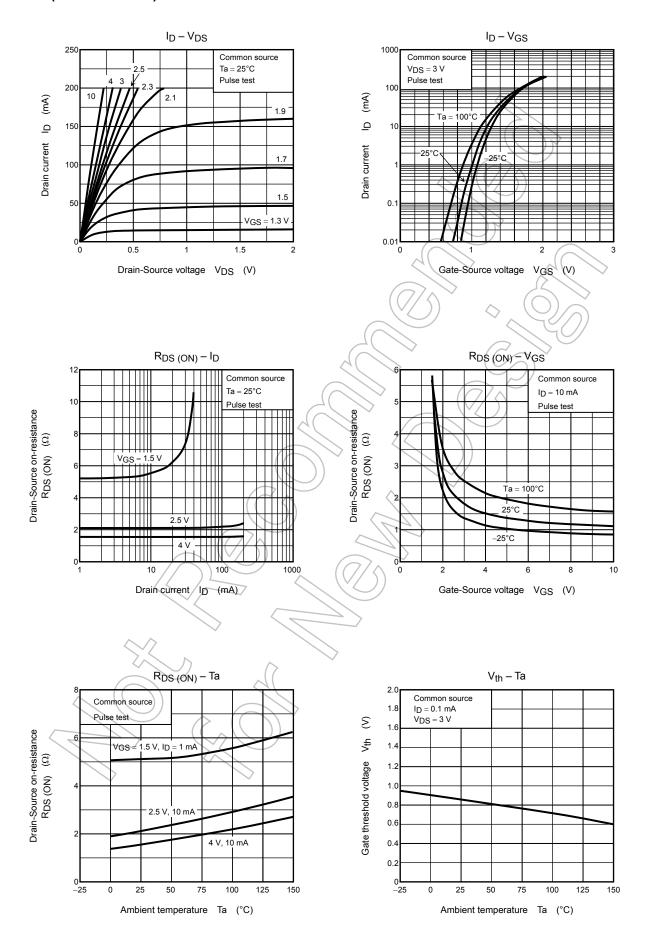
Precaution

 V_{th} can be expressed as the voltage between the gate and source when the low operating current value is $I_D = -0.1$ mA for this product. For normal switching operation, V_{GS} (on) requires a higher voltage than V_{th} and V_{GS} (off) requires a lower voltage than V_{th} . (The relationship can be established as follows: V_{GS} (off) $< V_{th} < V_{GS}$ (on).) Be sure to take this into consideration when using the device.

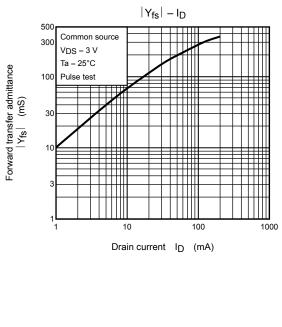
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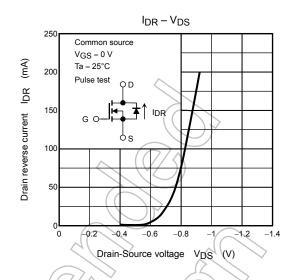
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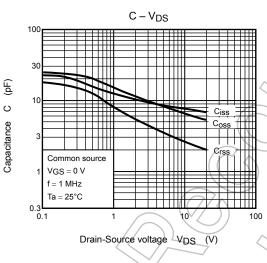
Q1 (N-ch MOSFET)

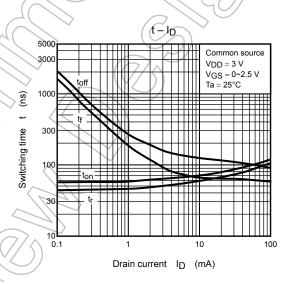


Q1 (N-ch MOSFET)





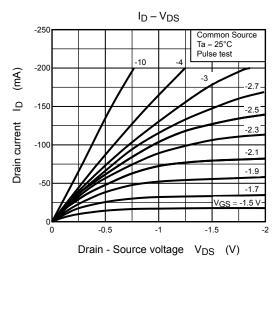


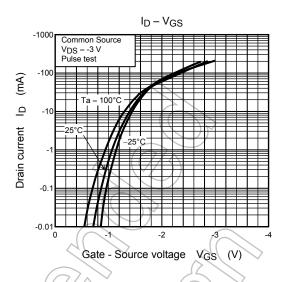


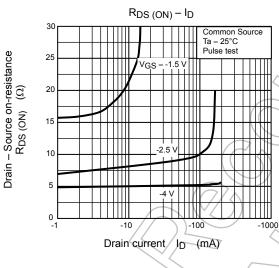
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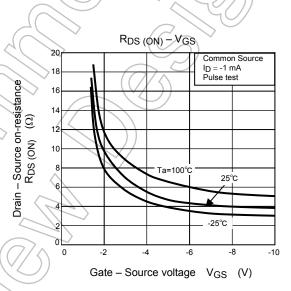
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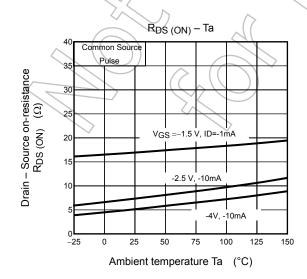
Q2 (P-ch MOSFET)

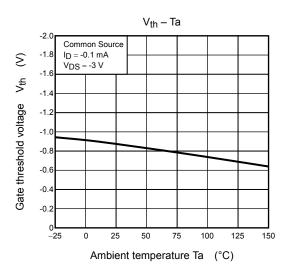




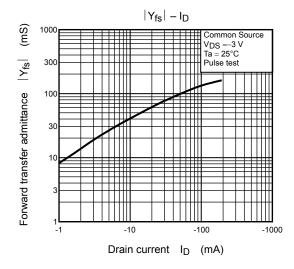


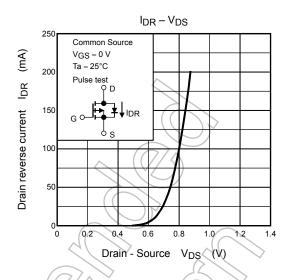


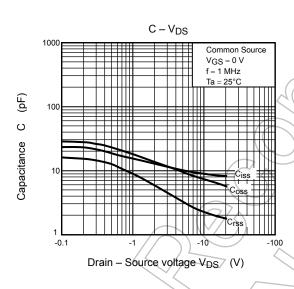


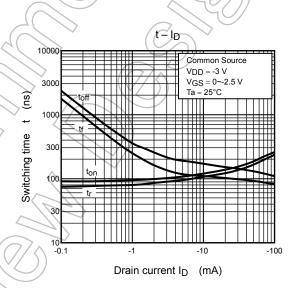


Q2 (P-ch MOSFET)

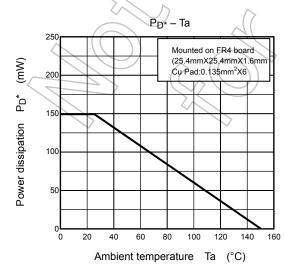








Common Characteristics



*:Total rating

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